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| Part Number     | Revision | Revision Content | Revised on |
|-----------------|----------|------------------|------------|
| ZJY130S0700TG01 | A        | New              | 2020-06-06 |
|                 |          |                  |            |
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## 1.General Description

ZJY130S0700TG01 is a 240RGB\*240 dots matrix TFT LCD module. It has a TFT panel composed of 720sources and 240gates. The LCM can be easily accessed by micro-controller.

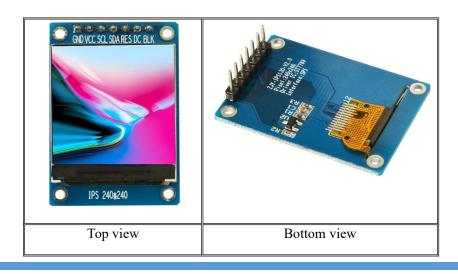
### 2. Features

| Dissilate Ma 1    | Transmissive                  |
|-------------------|-------------------------------|
| Display Mode      | a-TFT                         |
| Display Format    | Graphic 240RGB*240 Dot-matrix |
| Input Data        | SPI-4wire interface           |
| Viewing Direction | 12 o'clock                    |
| Drive             | ST7789VW                      |

## 3. Mechanical Specification

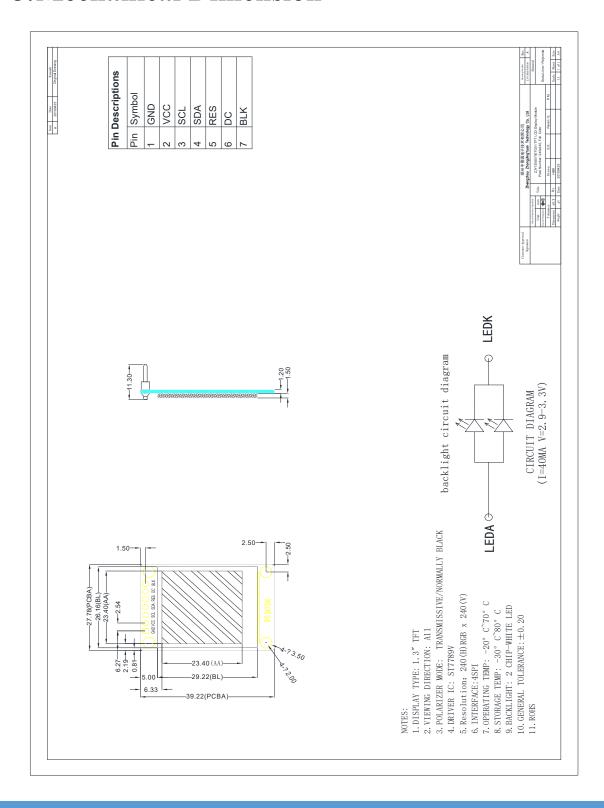
| Item                | Specifications           | Unit |
|---------------------|--------------------------|------|
| Dimensional outline | 27.78(W)*39.22(H)*2.7MAX | mm   |
| Resolution          | 240RGB*240               | dots |
| LCD Active area     | 23.4 (W)*23.4 (H)        | mm   |
| Pixel size          | 0.0975(W)*0.0975(H)      | mm   |

## 4. Product picture



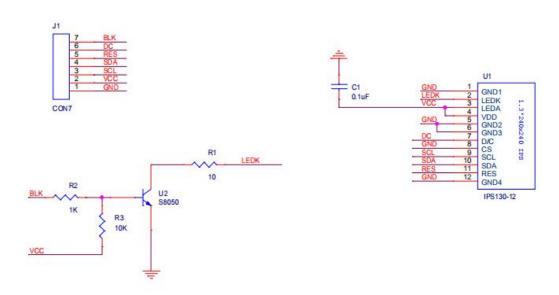
4

## 5. Mechanical Dimension



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## 6. Schematic diagram



## 7. Maximum Ratings

| Item                  | Symbol           | Min | Max | Unit | Note |
|-----------------------|------------------|-----|-----|------|------|
| Supply voltage        | VCC              | 3.0 | 3.3 | V    |      |
| Operating temperature | Topr             | -20 | 70  | C    |      |
| Storage temperature   | T <sub>STR</sub> | -30 | 80  | °C   |      |

## 8. Electrical Characteristics

| Item           |         | Symbol          | Condition  | Min.      | Тур. | Max.       | Unit |
|----------------|---------|-----------------|--|-----------|------|------------|------|
| Supply voltage | Logic   | $V_{CC}$        |  | 2.4       | 2.8  | 3.3        | V    |
| Innut Voltage  | H level | T <sub>IH</sub> |  | 0.8*IOVCC |      | IOVCC      | V    |
| Input Voltage  | L level | $T_{IL}$        |  | -0.3      |      | 0.2* IOVCC | V    |
| Storage temp   | erature | $I_{DD}$        | With internal voltage generation $V_{CC}$ =2.8V; $T_{emp}$ =25°C |           |      | TBD        | mA   |

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# 9. Backlight Characteristic

| Item                       | Symbol           | Min | Typical | Max | Unit  | Notes |
|----------------------------|------------------|-----|---------|-----|-------|-------|
| LED module Forward voltage | $V_{LED}$        | 2.8 | 3.2     | 3.3 | V     |       |
| LED module current         | I <sub>LED</sub> | 30  | -       | 40  | mA    | 2LED  |
| Brightness                 | Lbr              | 200 | 250     | -   | Cd/m³ |       |

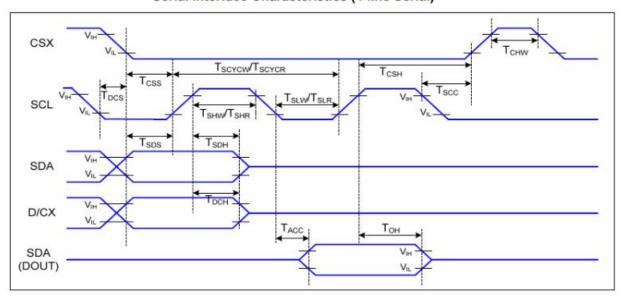
# **10. Module Function Description**

### 10.1 Pin Descriptions

| PIN No. | Symbol | Description  |
|---------|--------|--|
| 1       | CMD    | Ground of Logic Circuit  |
| 1       | GND    | This is a ground pin. It acts as a reference for the logic pins. It must be connected to external ground |
| 2       | VCC    | Power Supply for Logic   |
|         | VCC    | This is a voltage supply pin. It must be connected to external source                                    |
| 3       | SCL    | The serial clock input   |
| 4       | SDA    | The serial data input  |
|         |        | Power Reset for Controller and Driver  |
| 5       | RES    | This pin is reset signal input. When the pin is low, initialization                                      |
| 5       | KES    | of the chip is executed. Keep this pin pull high during normal   |
|         |        | operation  |
|         |        | Data/Command Control   |
| 6       | DC     | This pin is Data/Command control pin. When the pin is pulled high,                                       |
|         | DC     | the input at SDA is treated as display data. When the pin is pulled                                      |
|         |        | low, the input at SDA will be transferred to the command register.                                       |
|         |        | Backlight control pin  |
| 7       | BLK    | When the pin is pulled high turn on backlight, When the pin is pulled                                    |
|         |        | low turn off backlight   |

### 10.2 Timing characteristics.

#### Serial Interface Characteristics (4-line Serial)



4-line Serial Interface Timing

| Signal                 | Symbol | Parameter                      | MIN | MAX | Unit | Description                  |
|------------------------|--------|--------------------------------|-----|-----|------|------------------------------|
|                        | TCSS   | Chip Select Setup Time (Write) | TBD | 1   | ns   |                              |
|                        | TCSH   | Chip Select Hold Time (Write)  | TBD |     | ns   |                              |
| CSX                    | TCSS   | Chip Select Setup Time (Read)  | TBD |     | ns   |                              |
|                        | TSCC   | Chip Select Hold Time (Read)   | TBD |     | ns   |                              |
|                        | TCHW   | Chip Select "H" Pulse Width    | TBD |     | ns   |                              |
|                        | TSCYCW | Serial Clock Cycle (Write)     | TBD |     | ns   | Maita Cammand 9              |
|                        | TSHW   | SCL "H" Pulse Width (Write)    | TBD |     | ns   | -Write Command &<br>Data Ram |
| SCL                    | TSLW   | SCL "L" Pulse Width (Write)    | TBD |     | ns   | Data Raiii                   |
| SCL                    | TSCYCR | Serial Clock Cycle (Read)      | TBD |     | ns   | Dood Command 8               |
|                        | TSHR   | SCL "H" Pulse Width (Read)     | TBD |     | ns   | -Read Command &<br>Data Ram  |
|                        | TSLR   | SCL "L" Pulse Width (Read)     | TBD |     | ns   | Data Ram                     |
| D/CX                   | TDCS   | D/CX Setup Time                | TBD |     | ns   |                              |
| DICX                   | TDCH   | D/CX Hold Time                 | TBD |     | ns   |                              |
| CDA                    | TSDS   | Data Setup Time                | TBD |     | ns   |                              |
| SDA<br>(DIN)<br>(DOUT) | TSDH   | Data Hold Time                 | TBD |     | ns   | For Maximum CL=30pF          |
|                        | TACC   | Access Time                    | TBD | TBD | ns   | For Minimum CL=8pF           |
| (DOOT)                 | ТОН    | Output Disable Time            | TBD | TBD | ns   |                              |

4-line Serial Interface Characteristics

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### 10.3 Commands

Refer to the Technical Manual for the ST7789VW

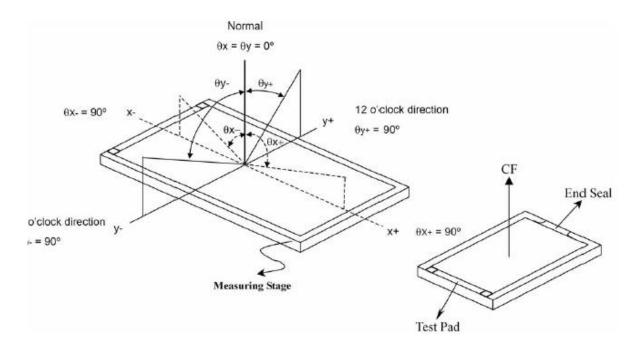
## 11. Electro-optical Characteristics

| Item                | Symbol                  | Conditions                      | Tem                     | Min. | Typ.  | Max.                 | Unit | Note  |
|---------------------|-------------------------|---------------------------------|-------------------------|------|-------|----------------------|------|-------|
| Daga anga Tima      | $T_R$                   | $\theta = \Phi = 0$             | 25℃                     |      | TBD   | TBD                  | msec | NOTE2 |
| Response Time       | $T_{\rm F}$             |                                 |                         |      | TBD   | TBD                  |      | NOTEZ |
| Viewing Angle Range | $\Phi = 0^{\circ} (6")$ | $\Phi = 90^{\circ} (3^{\circ})$ | $\Phi = 90^{\circ}(3")$ |      | (12") | $\Phi = 270^{\circ}$ | (9") | NOTE3 |
| θ (25°C) CR≥10      | TBD                     | TBD                             | - , ,                   |      |       | TBD                  |      | NOTE3 |

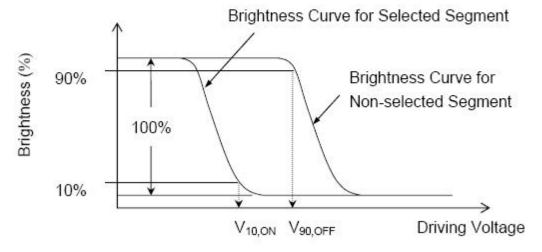
The above "viewing angle" is the measuring position with the largest contrast ratio. Not for good image quality. Viewing direction for good image quality is 12 O'clock.

- For panel only
- Electro-Optical Characteristics Test Method

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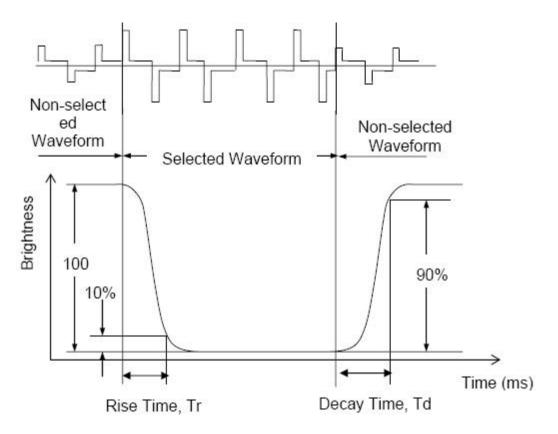


 $Vop = (V_{10, ON} + V_{90, OFF})/2$ 

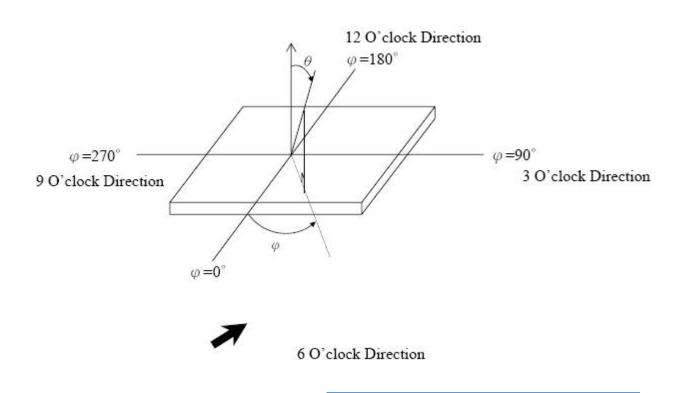


.Note2.Definition of Optical Response Time:

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. Note3.Definition of Viewing Angle  $\theta$  and  $\Phi$  :

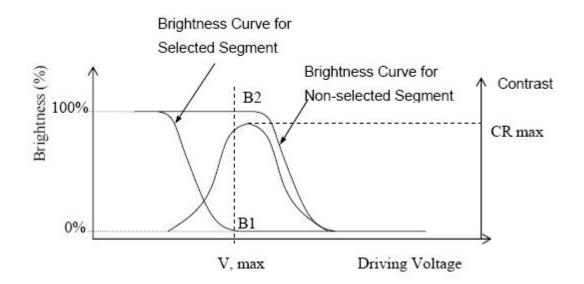


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#### **Note4.Definition of Contrast ratio (CR):**

CR = Brightness of Non-selected Segment (B2)
Brightness of Selected Segment (B1)



### 12. Reliability

#### 12.1 Mtbf

The LCD module shall be designed to meet a minimum MTBF value of 50000 hours with normal

#### 12.2 Test condition

| NO. | ITEM   | CONDITION                   | CRITERION                    |
|-----|--|-----------------------------|------------------------------|
| 1   | High Temperature Non-Operating Test          | 80°C*240Hrs                 | 。 No Defect Of Operational   |
| 2   | Low Temperature Non-Operating Test           | -30°C*240Hrs                | Function In Room Temperature |
| 3   | High Temperature/Humidity Non Operating Test | 60°C*90%RH*240Hrs           | Are Allowable                |
| 4   | High Temperature Operating Test              | 70°C*240Hrs                 | 。IDD of LCM in Pre-and       |
| 5   | Low Temperature Operating Test               | -20°C*240Hrs                | Post-Test Should Follow      |
| 6   | Thermal Shock Test                           | -20°C (30Min) ↔70°C (30Min) | Specification                |
|     | Thermal block rest                           | *10CYCLES                   |                              |

#### Notes:

- 1. Judgments should be made after exposure in room temperature for two hours.
- 2. The distill water is used for the high temperature/humidity test.
- 3. The sample above is individually for every reliability tests condition.

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## 13.Inspection standards

### 1.AQL(Acceptable Quality Level

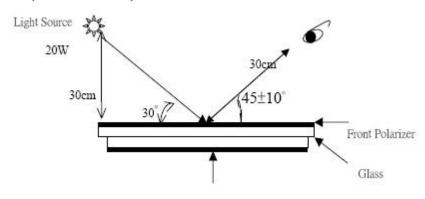
AQL of major and minor defect.

|     | MAJOR DEFECT | MINOR DEFECT |
|-----|--------------|--------------|
| AQL | 0.65         | 1.5          |

#### 2. Basic conditions for inspection

The LCM face to us, in normal environment, the lux is  $1000\pm200$ .(Darkroom's lux:  $100\pm50$ ), About an angle of incidence 30, a distance of 30 cm with an angle of 45 degree to check the products without uncovering the film!

#### (As shown below)



Rear Polarizer

#### 3.Inspection item and criteria

#### 3.1 Visual inspection criterion in immobility

#### 3.1.1Glass defect

| NO | Defect item                                      | Criteria   | Remark              |
|----|--|--|---------------------|
|    | Dimension  | By Engineering Drawing   |                     |
| 1  | Unconformity                                     |  |                     |
|    | (Major defect)                                   |  |                     |
| 2  | Cracks (Major defect)                            | <ol> <li>Linear cracks panel</li> <li>Reject</li> <li>Nonlinear crack contrast by limited sample</li> </ol>            |                     |
| 3  | Glass extrude the conductive area (minor defect) | a: disregards and no influence<br>assemblage.  1) b≤1/3Pin width(non bonding<br>area)  【Accept】  2)bonding area≤0. 5mm | A: Length, b: Width |

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|   |   | [Accept]  |   |
|---|---|---|---|
| 4 | Pin-side ,conductive area damaged (minor defect)          | (a c: disregards) b≤1/3of effective length for bonding electrode  【Accept】  | a: length, b: Width, c: Thickness       |
| 5 | Pin-side,non-conductive<br>area damaged<br>(minor defect) | 1)Damage area don't touch the ITO (Inclueling contraposition mark, except scribing mark)  [Accept] 2)C <t 3="" 3)c="T" 4)a="" [accept]="" b="" bm1="" disregards<="" glue="" not="" of="" seal="" th="" the="" touch="" width="" ≦=""><th>a: Length, b: Width c: Thickness</th></t> | a: Length, b: Width c: Thickness        |
| 6 | Non-pin-side damage<br>(minor defect)                     | c <t 1="" 1)b="" 3bm="" [reject]<="" b="" c="T" exceeds="" glue="" not="" seal="" th="" the="" touch=""><th>c: Thickness b: width of  BM 內緣  damage</th></t>  | c: Thickness b: width of  BM 內緣  damage |

3.1.2LCD appearance defect(View area)

| NO | Defect item                       | Criteria                                   |           | Remark                                  |
|----|-----------------------------------|--|-----------|---|
|    |                                   | Specification                              | Allowable | note1:L: Length, W: Width               |
|    |                                   | W ≤ 0.03mm                                 | disregard | note2: disregard if out of AA           |
|    | Fiber, glass                      | $0.03 \text{mm} < W \le 0.05 \text{mm};$   | 2         | <b>←</b> 1 →                            |
| 1  | cratch, polarizer                 | L ≤ 3. 0mm                                 | 2         |   |
|    | scratch/folded (minor defect)     | $0.05 \text{mm} < W \le 0.1 \text{mm};$    | 1         | V X                                     |
|    | (minor defect)                    | L ≦ 3.0mm                                  | 1         |   |
|    |                                   | W>0.1mm;L>3.0mm                            | 0         | W                                       |
|    |                                   | φ ≤ 0.2mm                                  | disregard | note1: $\Phi = (L+W)/2$ , L:Length,     |
| 2  | Polarizer bubble                  | $0.2$ mm $< \phi \le 0.3$ mm               | 2         | W :Width                                |
| 2  | concave and convex (minor defect) | $0.3$ mm $< \phi \le 0.5$ mm               | 1         | note2:disregard if out of AA            |
|    | (minor defect)                    | 0.5mm< ф                                   | 0         |   |
|    |                                   | φ ≤ 0.15mm                                 | disregard | note2:disregard if out of AA            |
|    | Black dots, dirty dots,           | $0.15 \text{mm} < \phi \le 0.25 \text{mm}$ | 2         |   |
| 3  |                                   | $0.25$ mm $< \phi \le 0.3$ mm              | 1         | - • • • • • • • • • • • • • • • • • • • |
|    | (minor defect)                    | 0.3mm< φ                                   | 0         | $\phi$                                  |
| 4  | Polarizer prick                   | φ ≦ 0.1mm                                  | disregard | note1: $\Phi = (L+W)/2$ , L=Length,     |

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| (minor defect) | $0.1$ mm $< \phi \le 0.25$ mm | 3 | W=Width                                 |
|----------------|-------------------------------|---|---|
|                | φ>0.25mm                      | 0 | note2:the distance between two dots>5mm |

### 3.1.3FPC

| NO | Defect item                   | Criteria           |           | Remark                    |
|----|-------------------------------|--------------------|-----------|---------------------------|
|    | Copper screen peel            | Copper screen pe   | el        |                           |
| 1  | (minor defect)                |                    | 【Reject】  |                           |
| 2  | No release tape or peel       | No release tape or | r peel    |                           |
|    |                               |                    | 【Reject】  |                           |
|    | Dirty dot and impurity of FPC | Specification      | Allowable | Note1: Cannot have stride |
| 3  | for customer using side       | φ ≤ 0.25mm         | 2         | ITO impurities            |
|    | (minor defect)                | Ф>0.25             | 0         |                           |

3.1.4Black tape &Mara tape

| NO | Defect item           | Criteria                   | Remark       |
|----|-----------------------|----------------------------|--------------|
|    | FPC or H/S black tape | 1. shift spec:             | LCD          |
|    |                       | 1) glue to the polarize    |              |
|    |                       | 【Reject】                   | x            |
|    | (minor defect)        | 2) IC bare 【Reject】        | + <u>-</u> - |
| 1  |                       | 2. left-and-right spec:    | y1           |
| 1  |                       | 1)exceed of FPC edge or    |              |
|    |                       | H-S edge 【Reject】          | ,, y2        |
|    |                       | 2) IC bare 【Reject】        | Mara tape    |
|    |                       |                            | X            |
|    | No black tape         | No black tape              | Heat Seal    |
| 2  |                       | -                          |              |
|    | (major defect)        | 【Reject】                   |              |
| 3  | Tape position mistake | Not by engineering drawing |              |
| 3  | (minor defect)        |                            |              |
|    | Mara tape defect      | Peel before pulling the    |              |
| 4  | (minor defect)        | protecting film            |              |
|    |                       | 【Reject】                   |              |

3.1.5Silicon and Taffy glue

| NO | Defect item            | Criteria                                  | Remark                              |
|----|------------------------|---|-------------------------------------|
| 1  | Quantity of silicon    | Uncover the ITO and circuit area          | note: compared by engineering       |
|    | (major defect)         | 【Reject】                                  |                                     |
| 2  | Taffy glue             | 1.Uncover the reveal copper area [Reject] | note: if customer has special       |
|    | (major defect)         | 2.Cover layer 0.3mm(Min)~3.0mm(Max)       | requirement, refer to the technical |
|    |                        | 【Reject】                                  | document                            |
|    |                        |   |                                     |
|    |                        |   |                                     |
|    |                        |   | 3.0mm(Max)                          |
| 3  | Depth of glue covering | Depth of glue covering overtop front      | Except of the special requirement   |
|    | (major defect)         | Polarizer 【Reject】                        |                                     |

3.2Electrical criteria

| NO | Defect item | Criteria | Remark |
|----|-------------|----------|--------|

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| 1  | No display                             | No display  |              |   |
|----|--|---|--------------|---|
|    | (major defect)                         | 【Reject】  |              |   |
| 2  | Missing line                           | Missing line                                      |              |   |
|    | (major defect)                         | 【Reject】  |              |   |
| 3  | Seg-com light and dark                 | Seg-com light and dark                            | ND filter 29 | % test  |
|    | (major defect)                         | 【Reject】  |              |   |
| 4  | No display in immobility               | No display in immobility                          |              |   |
|    | (major defect)                         | 【Reject】  |              |   |
| 5  | Flicker of Pattern                     | Flicker of Pattern                                |              |   |
|    | (major defect)                         | 【Reject】  |              |   |
| 6  | Mura                                   | ND filter 2%test                                  |              |   |
| 7  | (major defect) Over current            | 0   |              |   |
| '  | (major defect)                         | Over current [Reject]                             |              |   |
| 8  | Voltage out of specification           | Voltage out of                                    |              |   |
| 8  | (major defect)                         | specification                                     |              |   |
|    | (major defect)                         | [Reject]  |              |   |
| 9  | Pattern blur, error code               | Pattern blur, error code                          |              |   |
|    | (major defect)                         | 【Reject】  |              |   |
| 10 | Dark light, Flicker                    | Dark light, Flicker                               |              |   |
|    | (major defect)                         | 【Reject】  |              |   |
| 11 | Black/white dots Dirty                 | Specification                                     | Allowable    | Note1:disregard if out of AA                            |
|    | dots, eye winker                       | φ ≤ 0.15mm  | disregard    |   |
|    | (major defect)                         | $0.15 \text{mm} < \phi \le 0.25 \text{mm}$        | 2            | $\bigvee$ $\downarrow$ $\phi$                           |
|    |  | $0.25$ mm $< \phi \le 0.3$ mm                     | 1            |   |
|    |  | 0.3mm< φ  | 0            | 4   |
| 10 | F1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | W = 0.02  | 1: 1         | V 1 I I 4 W W 14  |
| 12 | Fiber, glass crutch, Polarizer         | W≦0.03mm  | disregard    | Note1:L: Length, W: Width Note2: disregard if out of AA |
|    | scratch/folded (major defect)          | $0.03 \text{mm} < \emptyset \le 0.0.05 \text{mm}$ | 2            | Note2. disregard if out of AA                           |
|    | (major defect)                         | L≤3.0mm   |              | <b>^</b> - <b>^</b> -                                   |
|    |  | $0.05$ mm $<$ W $\leq$ 0.1mm                      | 1            |   |
|    |  | L≤3.0mm   | -            | V /\  |
|    |  | W>0.1mm;L>3.0mm                                   | 0            | W   |

## 14.Precautions for using LCD modules.

### 14.1 Safety

- (1)Do mot swallow any liquid crystal ,even if there is no proof that liquid crystal is poisonous.
- (2)If the LCD panel breaks, be careful not to get liquid crystal to touch your skin.
- (3)If skin is exposed to liquid crystal, wash the area thoroughly with alcohol or soap.

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### 14.2 Srorang Conditions

- (4)Store the panel or module in a dark place where the temperature is  $23 \pm 5$  °C and the humidity is below 45  $\pm 20$ %RH.
- (5) Store in anti-static electricity container.
- (6) Store in clean environment, free from dust, active gas, and solvent.
- (7) Do not place the module near organics solvents or corrosive gases.
- (8) )Do not crush, shake, or jolt the module.

### 14.3 Handling Precautions

- (9) Avoid static electricity, which can damage the CMOS LSI.
- (10) The polarizing plate of the display is very fragile, please handle if very carefully.
- (11) Do not give external shock.
- (12)DO mot apply excessive force on the surface.
- (13)Bo not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- (14) Do not use ketonics solvent & Aromatic solvent, use with a soft cloth soaked with a cleaning naphtha solvent.
- (15) Do not operate it above the absolute maximum rating.
- (16) Do not remove the panel or frame from the module.

### 14.4Warranty

The period is within twelve months since the date of shipping out under normal using and storage conditions.

### 15. Revision history

| Version | Revise record    | Date       |
|---------|------------------|------------|
| v0.0    | Original version | 2020-06-06 |
|         |                  |            |
|         |                  |            |

## 16. The appendix

### ST7789VW\_initial

```
void LCD_Init(void)
   LCD_RES_C1r();//复位
   delay_ms(100);
   LCD_RES_Set();
    delay_ms(100);
   LCD_BLK_Set();//打开背光
 delay_ms(100);
   //******* Start Initial Sequence ******//
   LCD WR REG(0x11); //Sleep out
    delay ms (120);
                               //Delay 120ms
   //****** Start Initial Sequence ******//
   LCD_WR_REG(0x36);
   LCD_WR_DATA8(0x00);
   LCD_WR_REG(0x3A);
   LCD_WR_DATA8(0x05);
   LCD_WR_REG(0xB2);
   LCD_WR_DATA8(0x0C);
   LCD_WR_DATA8(0x0C);
   LCD_WR_DATA8(0x00);
   LCD WR DATA8 (0x33);
   LCD_WR_DATA8(0x33);
   LCD WR REG(0xB7);
   LCD_WR_DATA8(0x35);
   LCD_WR_REG(OxBB);
   LCD WR DATA8 (0x19);
   LCD_WR_REG(0xC0);
   LCD_WR_DATA8(0x2C);
   LCD_WR_REG(0xC2);
   LCD_WR_DATA8(0x01);
   LCD WR REG(0xC3);
   LCD_WR_DATA8(0x12);
```

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```
LCD_WR_REG(0xC4);
LCD_WR_DATA8(0x20);
LCD_WR_REG(0xC6);
LCD_WR_DATA8(OxOF);
LCD WR REG(0xD0);
LCD_WR_DATA8(OxA4);
LCD_WR_DATA8(OxA1);
LCD WR REG(0xE0);
LCD_WR_DATA8(OxDO);
LCD_WR_DATA8(0x04);
LCD_WR_DATA8(OxOD);
LCD_WR_DATA8(0x11);
LCD WR DATA8 (0x13);
LCD_WR_DATA8(0x2B);
LCD_WR_DATA8(0x3F);
LCD_WR_DATA8(0x54);
LCD_WR_DATA8(0x4C);
LCD_WR_DATA8(0x18);
LCD_WR_DATA8(OxOD);
LCD WR DATA8 (0x0B);
LCD_WR_DATA8(0x1F);
LCD_WR_DATA8(0x23);
LCD_WR_REG(0xE1);
LCD WR DATA8 (0xD0);
LCD_WR_DATA8(0x04);
LCD_WR_DATA8(0x0C);
LCD_WR_DATA8(0x11);
LCD_WR_DATA8(0x13);
LCD_WR_DATA8(0x2C);
LCD_WR_DATA8(0x3F);
LCD WR DATA8 (0x44);
LCD WR DATA8 (0x51);
LCD_WR_DATA8(0x2F);
LCD_WR_DATA8(0x1F);
LCD_WR_DATA8(0x1F);
LCD_WR_DATA8(0x20);
LCD_WR_DATA8(0x23);
LCD_WR_REG(0x21);
LCD_WR_REG(0x29);
```

}

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